

R-C Thermal Model Parameters

DESCRIPTION

The parametric values in the R-C thermal model have been derived using curve-fitting techniques. R-C values for the electrical circuit in the Foster/tank and Cauer/filter configurations are included. When implemented in P-SPICE, these values have matching characteristic curves to the single-pulse transient thermal impedance curves for the MOSFET.

These RC values can be used in the P-SPICE simulation to evaluate the thermal behavior of the MOSFET junction temperature under a defined power profile. These techniques are described in application note AN609, "Thermal Simulation of Power MOSFETs on the P-SPICE Platform".

R-C THERMAL MODEL FOR TANK CONFIGURATION



R-C VALUES FOR TANK CONFIGURATION			
THERMAL RESISTANCE (°C/W)			
Junction to	Ambient-Full Copper(FC)	Ambient-Minimum Copper(MC)	Foot
RT1	41.7716	52.8539	N/A
RT2	9.6630	38.0723	N/A
RT3	23.9352	58.5941	N/A
RT4	24.4879	40.8002	N/A
THERMAL CAPACITANCE (Joules/°C)			
Junction to	Ambient-Full Copper(FC)	Ambient-Minimum Copper(MC)	Foot
CT1	267.8702 u	829.7687 u	N/A
CT2	565.9177 m	57.9980 m	N/A
CT3	4.6510 m	4.8205 m	N/A
CT4	1.6538	583.1416 m	N/A

Note

N/A indicates not applicable

This document is intended as a SPICE modeling guideline and does not constitute a commercial product datasheet. Designers should refer to the appropriate datasheet of the same number for guaranteed specification limits.

R-C THERMAL MODEL FOR FILTER CONFIGURATION**R-C VALUES FOR FILTER CONFIGURATION**

THERMAL RESISTANCE (°C/W)			
Junction to	Ambient-Full Copper(FC)	Ambient-Minimum Copper(MC)	Foot
RF1	45.5917	75.5098	N/A
RF2	21.8254	54.0982	N/A
RF3	28.1334	29.6710	N/A
RF4	4.5611	29.9583	N/A
THERMAL CAPACITANCE (Joules/°C)			
Junction to	Ambient-Full Copper(FC)	Ambient-Minimum Copper(MC)	Foot
CF1	249.0576 u	721.3691 u	N/A
CF2	5.0482 m	6.4083 m	N/A
CF3	714.6096 m	102.6309 m	N/A
CF4	20.0003	657.3939 m	N/A

Note

N/A indicates not applicable

